

N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

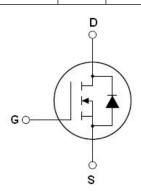
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

V _{DS min@Tjmax}	650	V
R _{DS(ON)TYP}	335	mΩ
ID	10	Α
Qg	13	nC



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE60N370K	TO-252	NCE60N370K



TO-252

Table 1. Absolute Maximum Ratings (T_c=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (VGS=0V)	VDS	600	V
Gate-Source Voltage (VDS=0V) AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (VDS=0V) DC	V _G s	±20	V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	10	Α
Continuous Drain Current at Tc=100°C	I _{D (DC)}	7	Α
Pulsed drain current (Note 1)	I _{DM} (pluse)	30	Α
Maximum Power Dissipation(Tc=25°C)	P _D	99	W
Derate above 25°C		0.66	W/°C
Avalanche current ^(Note 1)	I _{AR}	2	Α
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50	V/ns
Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub>	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55+175	°C

^{*} limited by maximum junction temperature



Table 2. Thermal Characteristic

Parameter	Symbol	Value	Unit
Thermal Resistance,Junction-to-Case(Maximum)	R_{thJC}	1.51	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	°C /W

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA 600				V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =600V,V _{GS} =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =600V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =5A		335	370	mΩ
Dynamic Characteristics						
Input Capacitance	C _{lss}	V 50VVV 0V		440		pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V, F=1.0MHz		32		pF
Reverse Transfer Capacitance	C _{rss}	F=1.0IVIH2		6		pF
Total Gate Charge	Qg			13		nC
Gate-Source Charge	Q _{gs}	V_{DS} =450 V , I_{D} =5 A ,		4.5		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V		3		nC
Gate plateau voltage	Vgp			5.5		V
Intrinsic gate resistance	R _G	f = 1 MHz open drain		42		Ω
Switching times						
Turn-on Delay Time	t _{d(on)}			8		nS
Turn-on Rise Time	t _r	V_{DD} =380 V , I_{D} =5 A ,		9		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=1.7\Omega, V_{GS}=10V$		42		nS
Turn-Off Fall Time	t _f			8		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T =25°C			10	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			30	Α
Forward On Voltage	V _{SD}	Tj=25°C,I _{SD} =10A,V _{GS} =0V		0.9	1.2	V
Reverse Recovery Time	t _{rr}	T:=05°C ! =5 A		140		nS
Reverse Recovery Charge	Qrr	Tj=25°C,I _F =5A, di/dt=100A/μs		0.63		uC
Peak Reverse Recovery Current	Irrm	ui/uι– 100 <i>Α</i> /μ5		9		Α

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25 $^{\circ}$ C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area

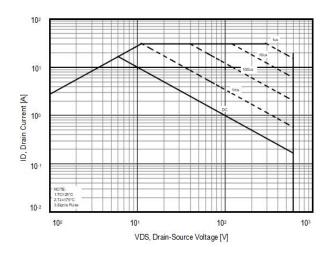


Figure 3. Source-Drain Diode Forward Voltage

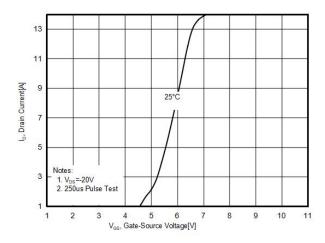


Figure 5. RDS(ON) vs Junction Temperature

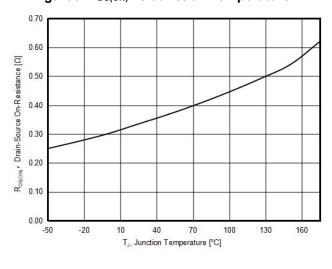


Figure 2. Capacitance

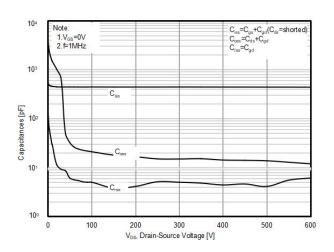


Figure 4. Output characteristics

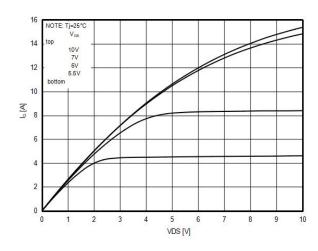


Figure 6. BVDSS vs Junction Temperature

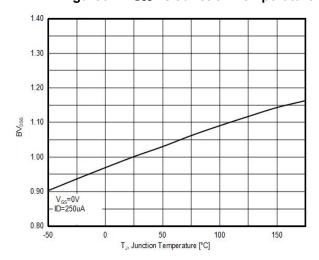




Figure 7. Maximum I_D vs Junction Temperature

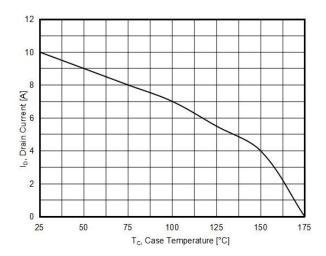


Figure 8. Gate charge waveforms

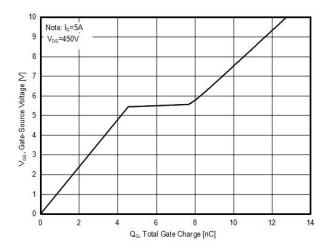


Figure 9. Static drain-source on resistance

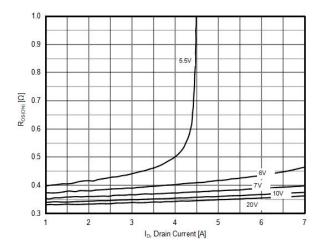
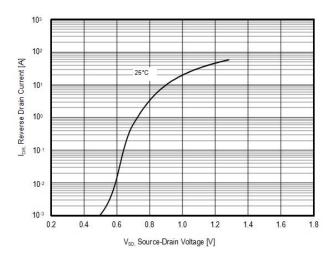


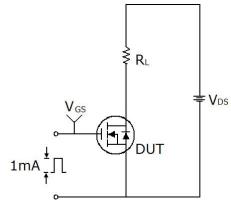
Figure 10. Source-Drain Diode Forward Voltage

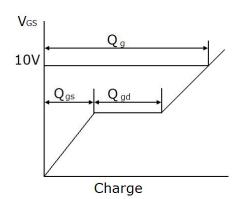




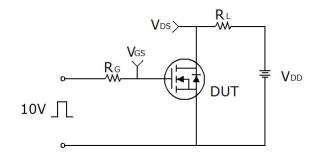
Test circuit

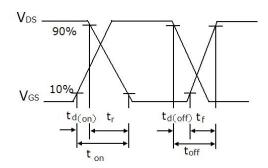
1) Gate charge test circuit & Waveform



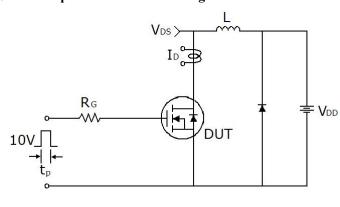


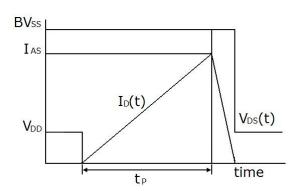
2) Switch Time Test Circuit:





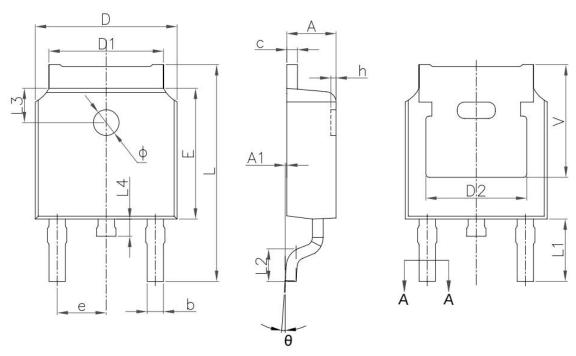
3) Unclamped Inductive Switching Test Circuit & Waveforms







TO-252-E Package Information



Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	2.20	2.40	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
b	0.66	0.83	0.026	0.033	
b1	0.73	0.79	0.029	0.031	
С	0.46	0.58	0.018	0.023	
c1	0.50	0.52	0.020	0.020	
D	6.50	6.70	0.256	0.264	
D1	5.10	5.46	0.201	0.215	
D2	4.83	REF	0.19REF		
Е	6.00	6.20	0.236 0.244		
е	2.19	2.39	0.086	0.094	
L	9.80	10.40	0.386	0.409	
L1	2.90	2.90 REF		REF	
L2	1.40	1.70	0.055		
L3	1.60	1.60 REF		REF	
L4	0.60	1.00	0.024	0.039	
Ф	1.10	1.30	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.00	0.30	0.000	0.012	



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